



Welcome to [E-XFL.COM](https://www.e-xfl.com)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | PIC |
| Core Size | 8-Bit |
| Speed | 20MHz |
| Connectivity | - |
| Peripherals | Brown-out Detect/Reset, LCD, POR, PWM, WDT |
| Number of I/O | 25 |
| Program Memory Size | 3.5KB (2K x 14) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 128 x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.8V ~ 3.6V |
| Data Converters | A/D 11x10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 125°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 28-SSOP (0.209", 5.30mm Width) |
| Supplier Device Package | 28-SSOP |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1902-e-ss |

2.0 ENHANCED MID-RANGE CPU

This family of devices contains an enhanced mid-range 8-bit CPU core. The CPU has 49 instructions. Interrupt capability includes automatic context saving. The hardware stack is 16 levels deep and has Overflow and Underflow Reset capability. Direct, Indirect, and Relative Addressing modes are available. Two File Select Registers (FSRs) provide the ability to read program and data memory.

- Automatic Interrupt Context Saving
- 16-level Stack with Overflow and Underflow
- File Select Registers
- Instruction Set

2.1 Automatic Interrupt Context Saving

During interrupts, certain registers are automatically saved in shadow registers and restored when returning from the interrupt. This saves stack space and user code. See **Section 7.5 “Automatic Context Saving”**, for more information.

2.2 16-level Stack with Overflow and Underflow

These devices have an external stack memory 15 bits wide and 16 words deep. A Stack Overflow or Underflow will set the appropriate bit (STKOVF or STKUNF) in the PCON register, and if enabled will cause a software Reset. See **Section 3.4 “Stack”** for more details.

2.3 File Select Registers

There are two 16-bit File Select Registers (FSR). FSRs can access all file registers and program memory, which allows one Data Pointer for all memory. When an FSR points to program memory, there is one additional instruction cycle in instructions using INDF to allow the data to be fetched. General purpose memory can now also be addressed linearly, providing the ability to access contiguous data larger than 80 bytes. There are also new instructions to support the FSRs. See **Section 3.5 “Indirect Addressing”** for more details.

2.4 Instruction Set

There are 49 instructions for the enhanced mid-range CPU to support the features of the CPU. See **Section 20.0 “Instruction Set Summary”** for more details.

PIC16LF1902/3

3.0 MEMORY ORGANIZATION

These devices contain the following types of memory:

- Program Memory
 - Configuration Words
 - Device ID
 - User ID
 - Flash Program Memory
- Data Memory
 - Core Registers
 - Special Function Registers
 - General Purpose RAM
 - Common RAM

The following features are associated with access and control of program memory and data memory:

- PCL and PCLATH
- Stack
- Indirect Addressing

3.1 Program Memory Organization

The enhanced mid-range core has a 15-bit program counter capable of addressing 32K x 14 program memory space. Table 3-1 shows the memory sizes implemented for the PIC16LF1902/3 family. Accessing a location above these boundaries will cause a wrap-around within the implemented memory space. The Reset vector is at 0000h and the interrupt vector is at 0004h (see Figures 3-1, and 3-2).

TABLE 3-1: DEVICE SIZES AND ADDRESSES

| Device | Program Memory Space (Words) | Last Program Memory Address | High-Endurance Flash Memory Address Range ⁽¹⁾ |
|-------------|------------------------------|-----------------------------|--|
| PIC16LF1902 | 2,048 | 07FFh | 0780h-07FFh |
| PIC16LF1903 | 4,096 | 0FFFh | 0F80h-0FFFh |

Note 1: High-endurance Flash applies to low byte of each address in the range.

4.0 DEVICE CONFIGURATION

Device Configuration consists of Configuration Word 1 and Configuration Word 2, Code Protection and Device ID.

4.1 Configuration Words

There are several Configuration Word bits that allow different oscillator and memory protection options. These are implemented as Configuration Word 1 at 8007h and Configuration Word 2 at 8008h.

| |
|---|
| Note: The <code>DEBUG</code> bit in Configuration Words is managed automatically by device development tools including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'. |
|---|

REGISTER 4-2: CONFIGURATION WORD 2

| | | | | | |
|--------------------|----------------------|-------|---------------------|--------|-------|
| R/P-1 | R/P-1 | R/P-1 | R/P-1 | R/P-1 | U-1 |
| LVP ⁽¹⁾ | DEBUG ⁽²⁾ | LPBOR | BORV ⁽³⁾ | STVREN | — |
| bit 13 | | | | | bit 8 |

| | | | | | | | |
|-------|-----|-----|-----|-----|-----|----------|-------|
| U-1 | U-1 | U-1 | U-1 | U-1 | U-1 | R/P-1 | R/P-1 |
| — | — | — | — | — | — | WRT<1:0> | |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

P = Programmable bit

U = Unimplemented bit, read as '1'

'0' = Bit is cleared

'1' = Bit is set

-n = Value when blank or after Bulk Erase

- bit 13 **LVP:** Low-Voltage Programming Enable bit⁽¹⁾
 1 = Low-voltage programming enabled
 0 = High-voltage on MCLR must be used for programming
- bit 12 **DEBUG:** In-Circuit Debugger Mode bit⁽²⁾
 1 = In-Circuit Debugger disabled, ICSPCLK and ICSPDAT are general purpose I/O pins
 0 = In-Circuit Debugger enabled, ICSPCLK and ICSPDAT are dedicated to the debugger
- bit 11 **LPBOR:** Low-Power BOR bit
 1 = Low-Power BOR is disabled
 0 = Low-Power BOR is enabled
- bit 10 **BORV:** Brown-out Reset Voltage Selection bit⁽³⁾
 1 = Brown-out Reset voltage (VBOR), low trip point selected
 0 = Brown-out Reset voltage (VBOR) high trip point selected
- bit 9 **STVREN:** Stack Overflow/Underflow Reset Enable bit
 1 = Stack Overflow or Underflow will cause a Reset
 0 = Stack Overflow or Underflow will not cause a Reset
- bit 8-2 **Unimplemented:** Read as '1'
- bit 1-0 **WRT<1:0>:** Flash Memory Self-Write Protection bits
2 kW Flash memory (PIC16LF1902 only):
 11 = Write protection off
 10 = 000h to 1FFh write-protected, 200h to 7FFh may be modified by PMCON control
 01 = 000h to 3FFh write-protected, 400h to 7FFh may be modified by PMCON control
 00 = 000h to 7FFh write-protected, no addresses may be modified by PMCON control
4 kW Flash memory (PIC16LF1903 only):
 11 = Write protection off
 10 = 000h to 1FFh write-protected, 200h to FFFh may be modified by PMCON control
 01 = 000h to 7FFh write-protected, 800h to FFFh may be modified by PMCON control
 00 = 000h to FFFh write-protected, no addresses may be modified by PMCON control

Note 1: The LVP bit cannot be programmed to '0' when Programming mode is entered via LVP.

2: The DEBUG bit in Configuration Words is managed automatically by device development tools including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'.

3: See VBOR parameter for specific trip point voltages.

6.3 Clock Switching

The system clock source can be switched between external and internal clock sources via software using the System Clock Select (SCS) bits of the OSCCON register. The following clock sources can be selected using the SCS bits:

- Default system oscillator determined by FOSC bits in Configuration Word 1
- Secondary oscillator 32 kHz crystal
- Internal Oscillator Block (INTOSC)

6.3.1 SYSTEM CLOCK SELECT (SCS) BITS

The System Clock Select (SCS) bits of the OSCCON register selects the system clock source that is used for the CPU and peripherals.

- When the SCS bits of the OSCCON register = 00, the system clock source is determined by value of the FOSC<1:0> bits in the Configuration Word 1.
- When the SCS bits of the OSCCON register = 01, the system clock source is the secondary oscillator.
- When the SCS bits of the OSCCON register = 1x, the system clock source is chosen by the internal oscillator frequency selected by the IRCF<3:0> bits of the OSCCON register. After a Reset, the SCS bits of the OSCCON register are always cleared.

When switching between clock sources, a delay is required to allow the new clock to stabilize. These oscillator delays are shown in Table 6-2.

6.3.2 OSCILLATOR START-UP TIME-OUT STATUS (OSTS) BIT

The Oscillator Start-up Time-out Status (OSTS) bit of the OSCSTAT register indicates whether the system clock is running from the external clock source, as defined by the FOSC<1:0> bits in the Configuration Word 1, or from the internal clock source.

6.3.3 SECONDARY OSCILLATOR

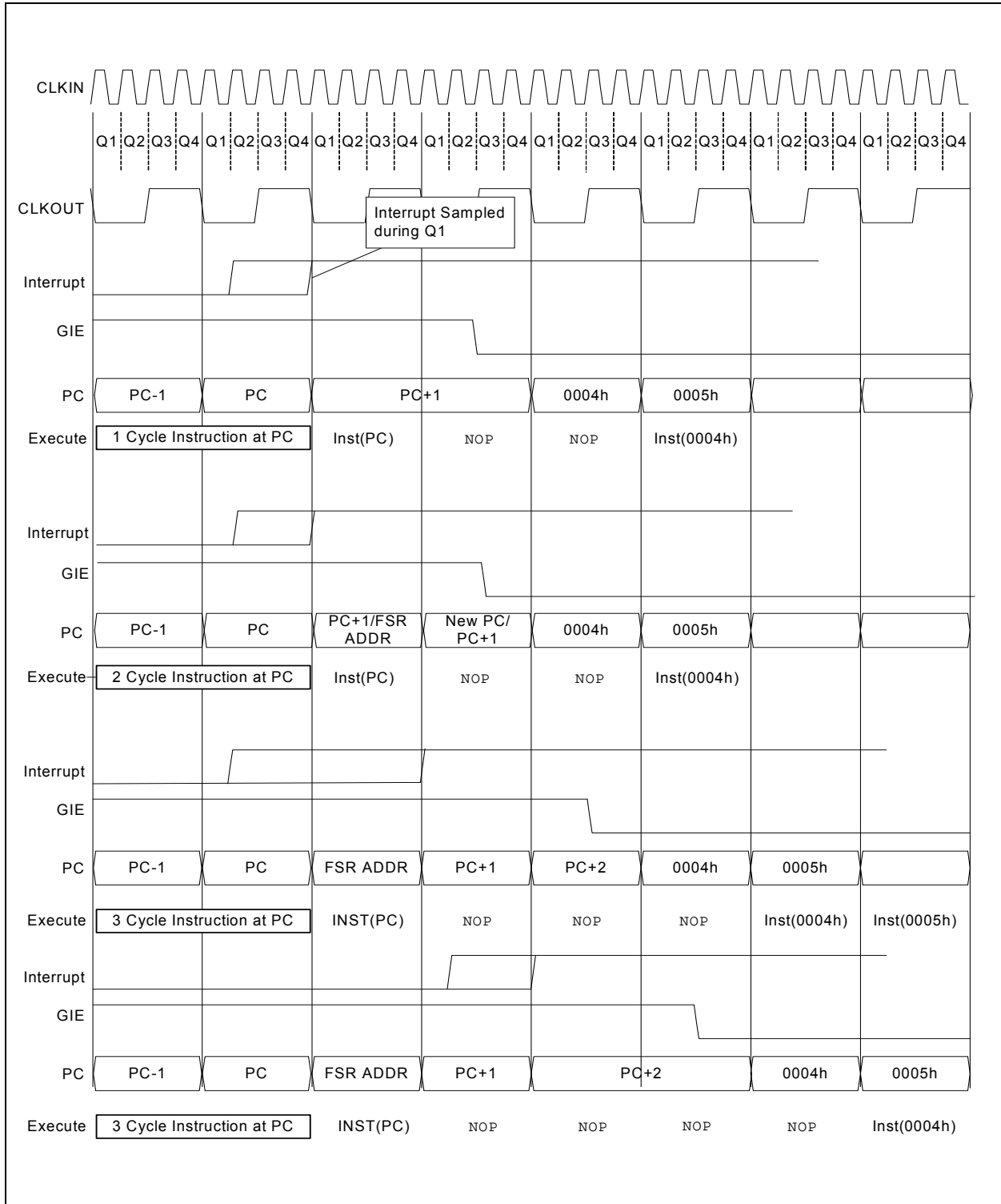
The secondary oscillator is a separate crystal oscillator associated with the Timer1 peripheral. It is optimized for timekeeping operations with a 32.768 kHz crystal connected between the T1OSI and T1CKI/T1OSO device pins.

The secondary oscillator is enabled using the T1OSCEN control bit in the T1CON register. See **Section 17.0 “Timer1 Module with Gate Control”** for more information about the Timer1 peripheral.

6.3.4 SECONDARY OSCILLATOR READY (T1OSCR) BIT

The user must ensure that the secondary oscillator is ready to be used before it is selected as a system clock source. The Secondary Oscillator Ready (T1OSCR) bit of the OSCSTAT register indicates whether the secondary oscillator is ready to be used. After the T1OSCR bit is set, the SCS bits can be configured to select the secondary oscillator.

FIGURE 7-2: INTERRUPT LATENCY



EXAMPLE 10-2: ERASING ONE ROW OF PROGRAM MEMORY

```

; This row erase routine assumes the following:
; 1. A valid address within the erase row is loaded in ADDRHI:ADDRL
; 2. ADDRHI and ADDRL are located in shared data memory 0x70 - 0x7F (common RAM)

      BCF      INTCON,GIE      ; Disable ints so required sequences will execute properly
      BANKSEL  PMADRL
      MOVF     ADDRL,W         ; Load lower 8 bits of erase address boundary
      MOVWF    PMADRL
      MOVF     ADDRHI,W        ; Load upper 6 bits of erase address boundary
      MOVWF    PMADRH
      BCF      PMCON1,CFGSR    ; Not configuration space
      BSF      PMCON1,FREER    ; Specify an erase operation
      BSF      PMCON1,WREN     ; Enable writes

      MOVLW    55h             ; Start of required sequence to initiate erase
      MOVWF    PMCON2          ; Write 55h
      MOVLW    0AAh           ;
      MOVWF    PMCON2          ; Write AAh
      BSF      PMCON1,WR       ; Set WR bit to begin erase
      NOP      ; NOP instructions are forced as processor starts
      NOP      ; row erase of program memory.
      ;
      ; The processor stalls until the erase process is complete
      ; after erase processor continues with 3rd instruction

      BCF      PMCON1,WREN     ; Disable writes
      BSF      INTCON,GIE     ; Enable interrupts

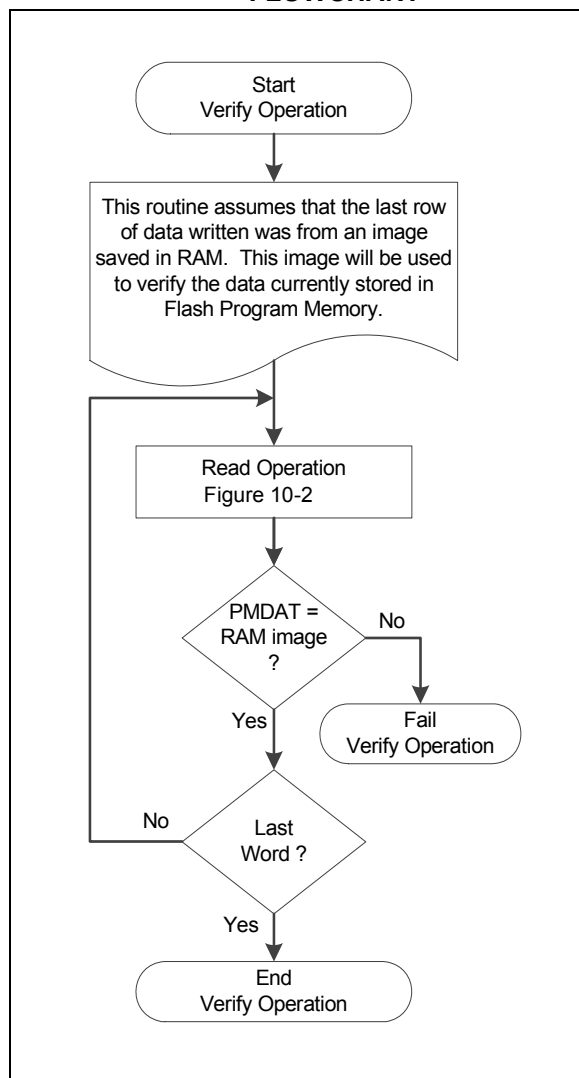
```

Required
Sequence

10.5 Write Verify

It is considered good programming practice to verify that program memory writes agree with the intended value. Since program memory is stored as a full page then the stored program memory contents are compared with the intended data stored in RAM after the last write is complete.

FIGURE 10-8: FLASH PROGRAM MEMORY VERIFY FLOWCHART



REGISTER 11-15: WPUE: WEAK PULL-UP PORTE REGISTER

| | | | | | | | |
|-------|-----|-----|-----|---------|-----|-----|-------|
| U-0 | U-0 | U-0 | U-0 | R/W-1/1 | U-0 | U-0 | U-0 |
| — | — | — | — | WPUE3 | — | — | — |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

bit 7-4 **Unimplemented:** Read as '0'

bit 3 **WPUE:** Weak Pull-up Register bit

1 = Pull-up enabled

0 = Pull-up disabled

bit 2-0 **Unimplemented:** Read as '0'

Note 1: Global $\overline{\text{WPUEN}}$ bit of the OPTION_REG register must be cleared for individual pull-ups to be enabled.

2: The weak pull-up device is automatically disabled if the pin is configured as an output.

TABLE 11-9: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

| Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Register on Page |
|--------|-------|----------|-------|-------|------------------|-------|------------------------------|-------|------------------|
| ADCON0 | — | CHS<4:0> | | | | | GO/ $\overline{\text{DONE}}$ | ADON | 112 |
| PORTE | — | — | — | — | RE3 | — | — | — | 98 |
| TRISE | — | — | — | — | — ⁽¹⁾ | — | — | — | 98 |
| WPUE | — | — | — | — | WPUE3 | — | — | — | 99 |

Legend: x = unknown, u = unchanged, — = unimplemented locations read as '0'. Shaded cells are not used by PORTE.

Note 1: Unimplemented, read as '1'.

15.1.5 INTERRUPTS

The ADC module allows for the ability to generate an interrupt upon completion of an Analog-to-Digital conversion. The ADC Interrupt Flag is the ADIF bit in the PIR1 register. The ADC Interrupt Enable is the ADIE bit in the PIE1 register. The ADIF bit must be cleared in software.

- Note 1:** The ADIF bit is set at the completion of every conversion, regardless of whether or not the ADC interrupt is enabled.

2: The ADC operates during Sleep only when the FRC oscillator is selected.

This interrupt can be generated while the device is operating or while in Sleep. If the device is in Sleep, the interrupt will wake-up the device. Upon waking from Sleep, the next instruction following the `SLEEP` instruction is always executed. If the user is attempting to wake-up from Sleep and resume in-line code execution, the GIE and PEIE bits of the INTCON register must be disabled. If the GIE and PEIE bits of the INTCON register are enabled, execution will switch to the Interrupt Service Routine.

15.1.6 RESULT FORMATTING

The 10-bit A/D conversion result can be supplied in two formats, left justified or right justified. The ADFM bit of the ADCON1 register controls the output format.

Figure 15-3 shows the two output formats.

FIGURE 15-3: 10-BIT A/D CONVERSION RESULT FORMAT

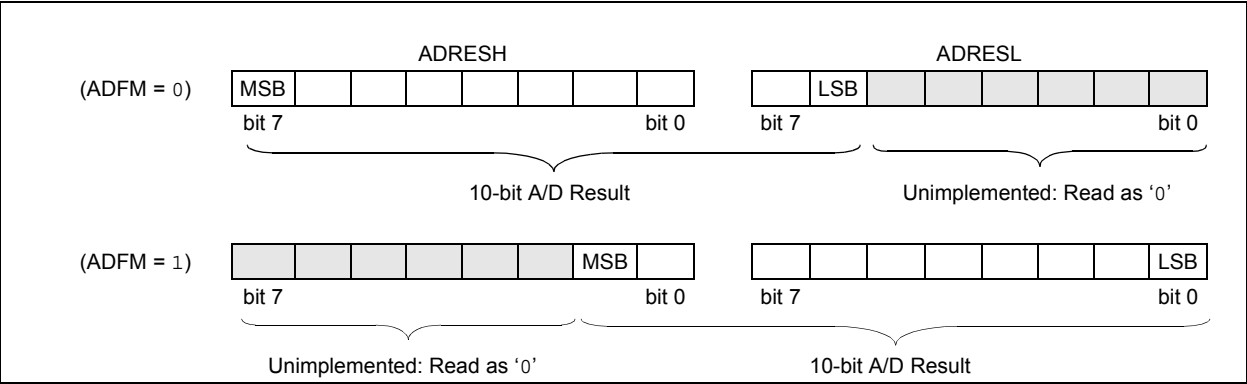


FIGURE 15-4: ANALOG INPUT MODEL

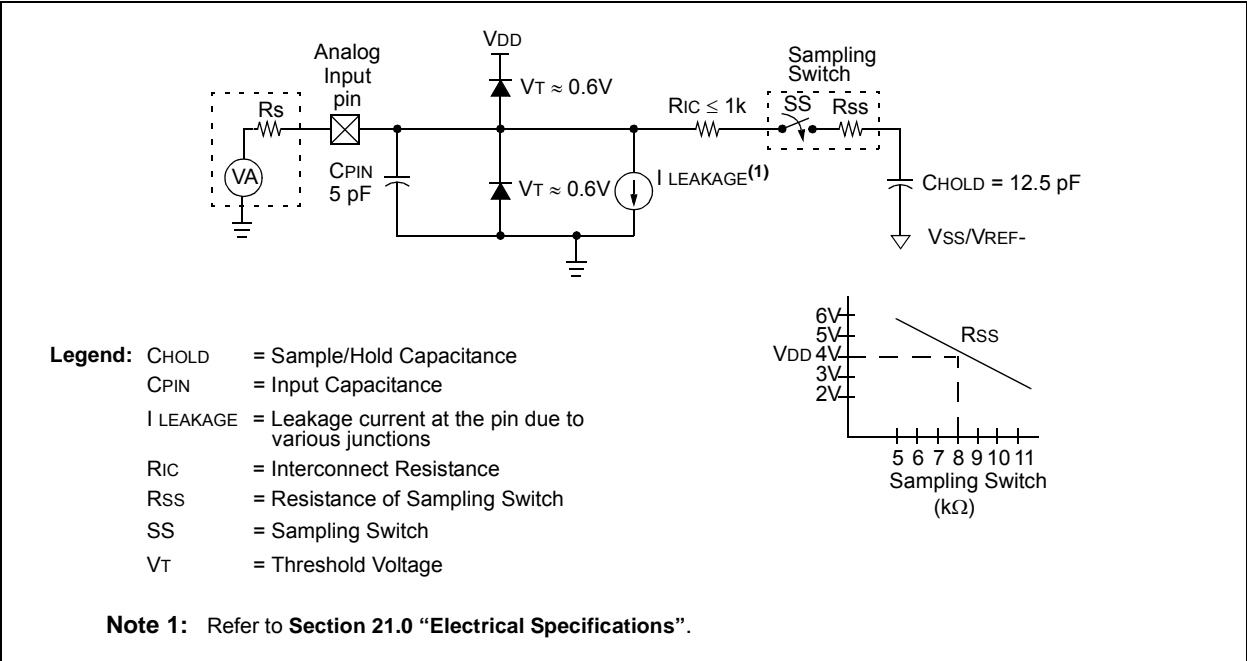
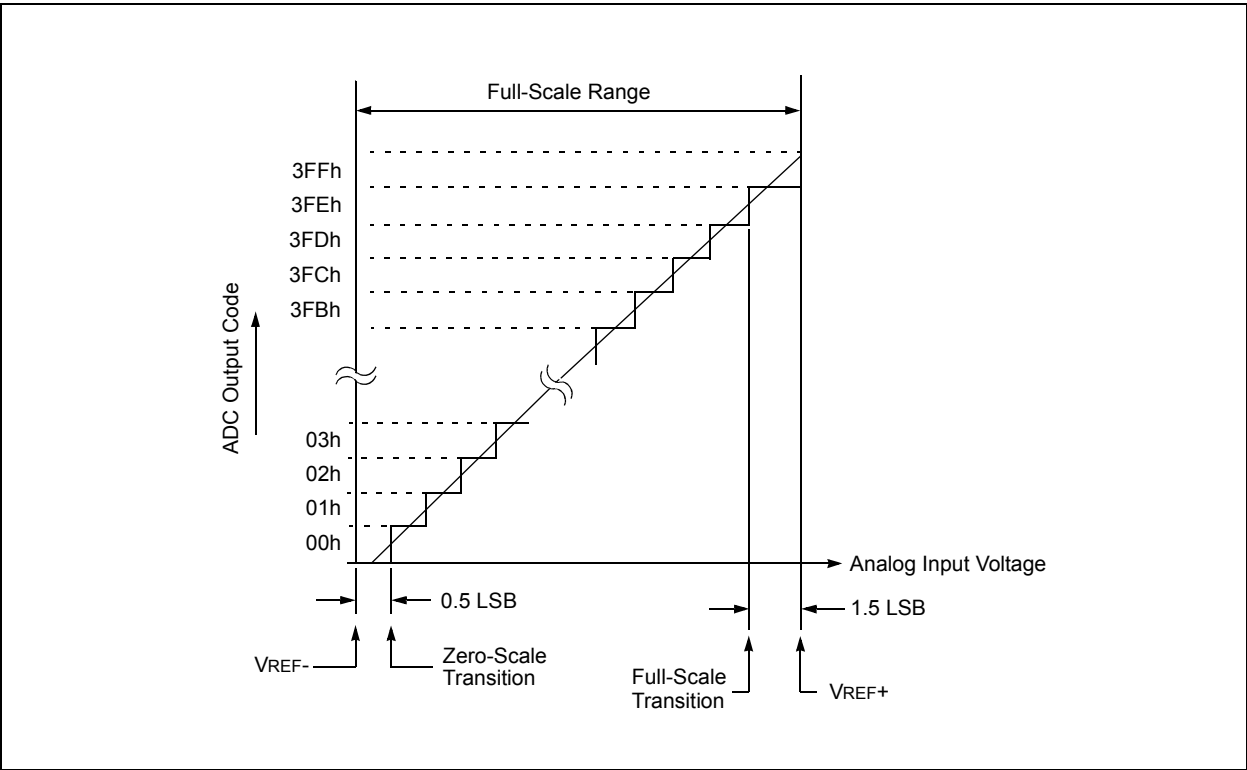


FIGURE 15-5: ADC TRANSFER FUNCTION



PIC16LF1902/3

FIGURE 18-11: TYPE-A WAVEFORMS IN 1/2 MUX, 1/3 BIAS DRIVE

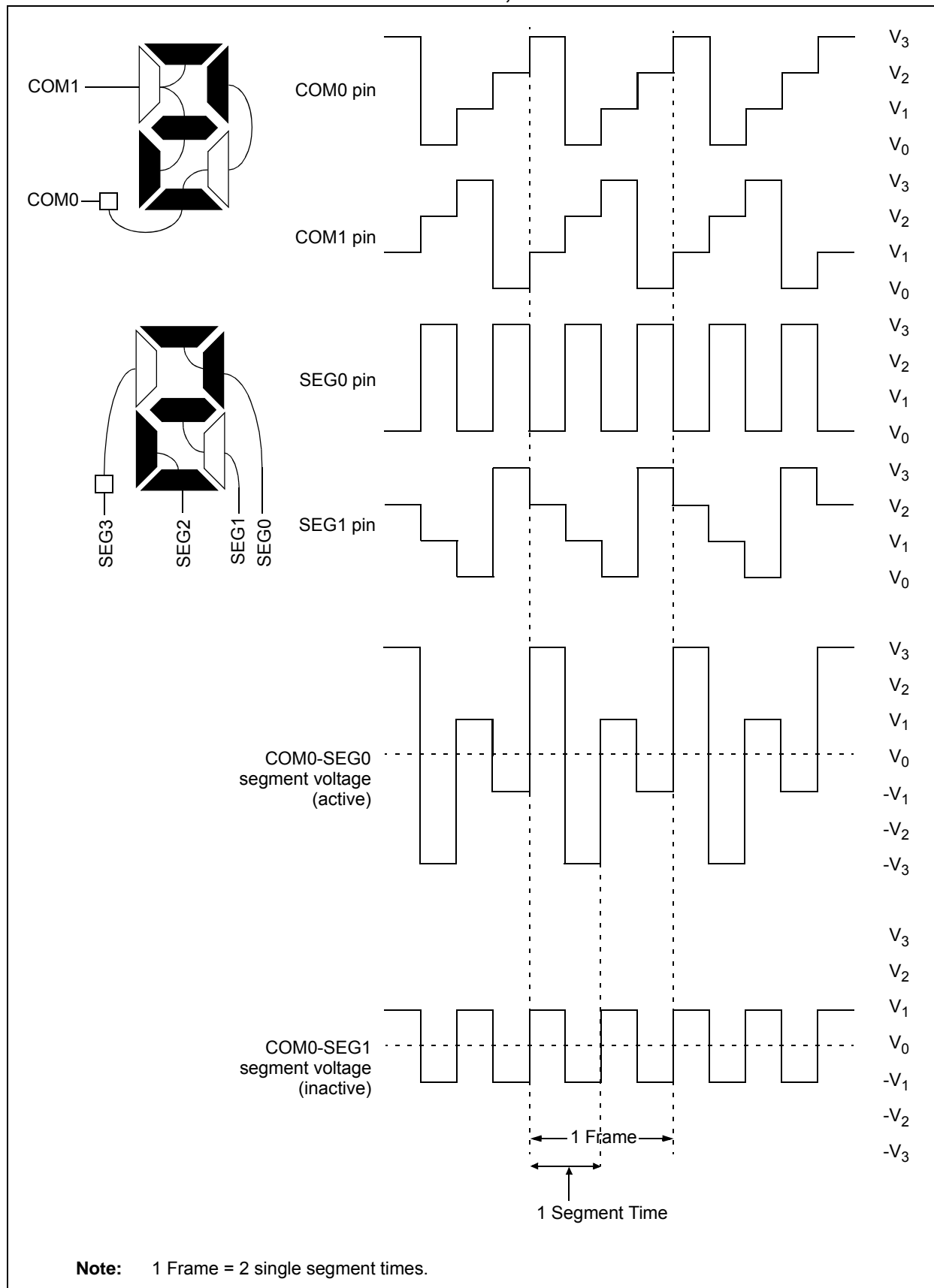
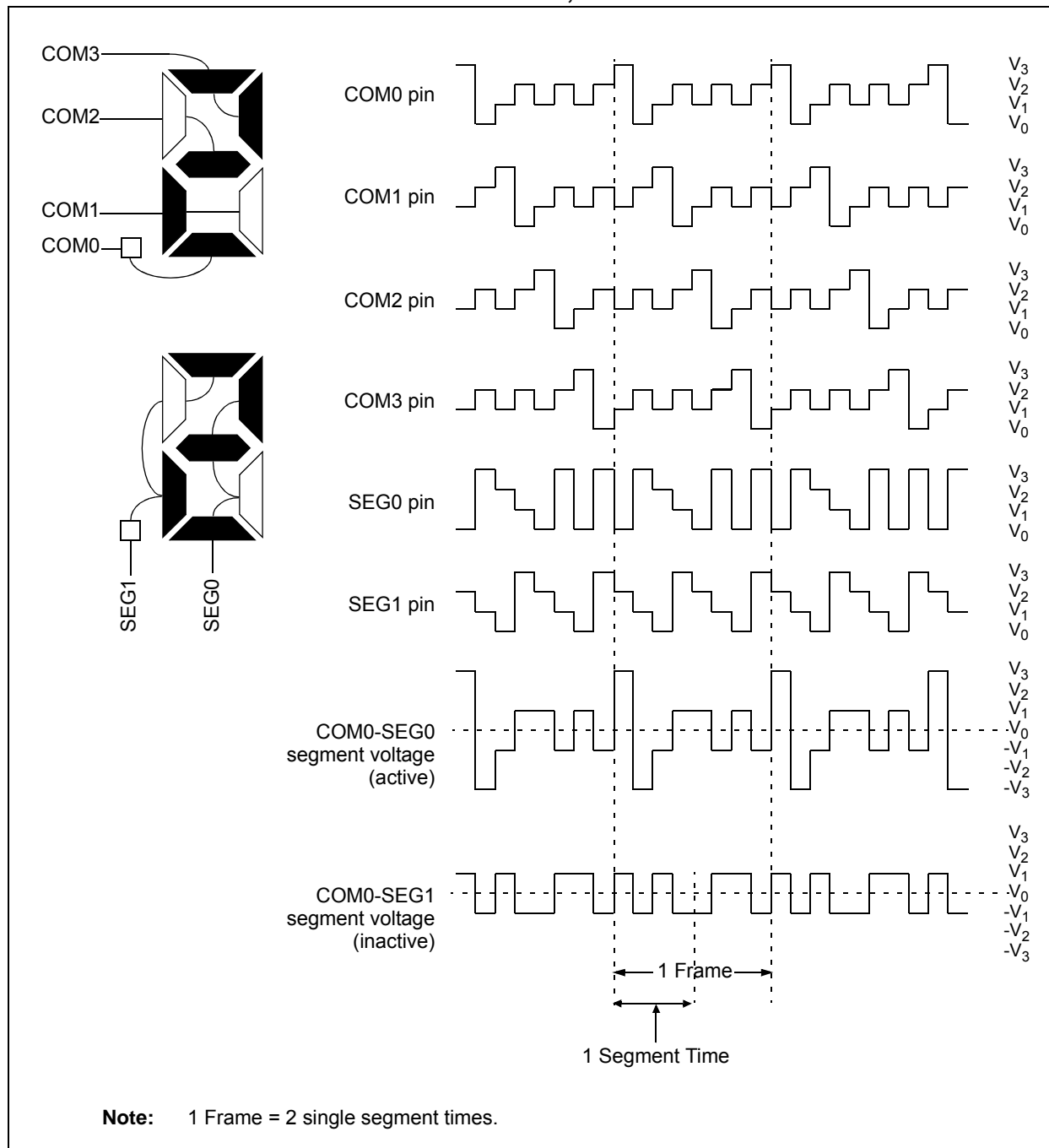


FIGURE 18-17: TYPE-A WAVEFORMS IN 1/4 MUX, 1/3 BIAS DRIVE



PIC16LF1902/3

| BCF | Bit Clear f |
|------------------|--|
| Syntax: | [<i>label</i>] BCF f,b |
| Operands: | $0 \leq f \leq 127$ $0 \leq b \leq 7$ |
| Operation: | $0 \rightarrow (f)$ |
| Status Affected: | None |
| Description: | Bit 'b' in register 'f' is cleared. |

| BTFSC | Bit Test f, Skip if Clear |
|------------------|---|
| Syntax: | [<i>label</i>] BTFSC f,b |
| Operands: | $0 \leq f \leq 127$ $0 \leq b \leq 7$ |
| Operation: | skip if $(f) = 0$ |
| Status Affected: | None |
| Description: | If bit 'b' in register 'f' is '1', the next instruction is executed. If bit 'b', in register 'f', is '0', the next instruction is discarded, and a NOP is executed instead, making this a 2-cycle instruction. |

| BRA | Relative Branch |
|------------------|---|
| Syntax: | [<i>label</i>] BRA label [<i>label</i>] BRA \$+k |
| Operands: | $-256 \leq \text{label} - \text{PC} + 1 \leq 255$ $-256 \leq k \leq 255$ |
| Operation: | $(\text{PC}) + 1 + k \rightarrow \text{PC}$ |
| Status Affected: | None |
| Description: | Add the signed 9-bit literal 'k' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be $\text{PC} + 1 + k$. This instruction is a 2-cycle instruction. This branch has a limited range. |

| BTFSS | Bit Test f, Skip if Set |
|------------------|---|
| Syntax: | [<i>label</i>] BTFSS f,b |
| Operands: | $0 \leq f \leq 127$ $0 \leq b < 7$ |
| Operation: | skip if $(f) = 1$ |
| Status Affected: | None |
| Description: | If bit 'b' in register 'f' is '0', the next instruction is executed. If bit 'b' is '1', then the next instruction is discarded and a NOP is executed instead, making this a 2-cycle instruction. |

| BRW | Relative Branch with W |
|------------------|--|
| Syntax: | [<i>label</i>] BRW |
| Operands: | None |
| Operation: | $(\text{PC}) + (W) \rightarrow \text{PC}$ |
| Status Affected: | None |
| Description: | Add the contents of W (unsigned) to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be $\text{PC} + 1 + (W)$. This instruction is a 2-cycle instruction. |

| BSF | Bit Set f |
|------------------|--|
| Syntax: | [<i>label</i>] BSF f,b |
| Operands: | $0 \leq f \leq 127$ $0 \leq b \leq 7$ |
| Operation: | $1 \rightarrow (f)$ |
| Status Affected: | None |
| Description: | Bit 'b' in register 'f' is set. |

LSLF Logical Left Shift

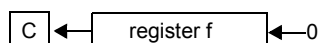
Syntax: `[label] LSLF f{,d}`

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(f<7>) \rightarrow C$
 $(f<6:0>) \rightarrow \text{dest}<7:1>$
 $0 \rightarrow \text{dest}<0>$

Status Affected: C, Z

Description: The contents of register 'f' are shifted one bit to the left through the Carry flag. A '0' is shifted into the LSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.



LSRF Logical Right Shift

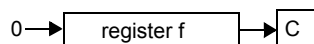
Syntax: `[label] LSRF f{,d}`

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $0 \rightarrow \text{dest}<7>$
 $(f<7:1>) \rightarrow \text{dest}<6:0>$,
 $(f<0>) \rightarrow C$,

Status Affected: C, Z

Description: The contents of register 'f' are shifted one bit to the right through the Carry flag. A '0' is shifted into the MSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.



MOVF Move f

Syntax: `[label] MOVF f,d`

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(f) \rightarrow (\text{dest})$

Status Affected: Z

Description: The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.

Words: 1

Cycles: 1

Example: `MOVF FSR, 0`

After Instruction
W = value in FSR register
Z = 1

21.2 DC Characteristics

TABLE 21-1: SUPPLY VOLTAGE

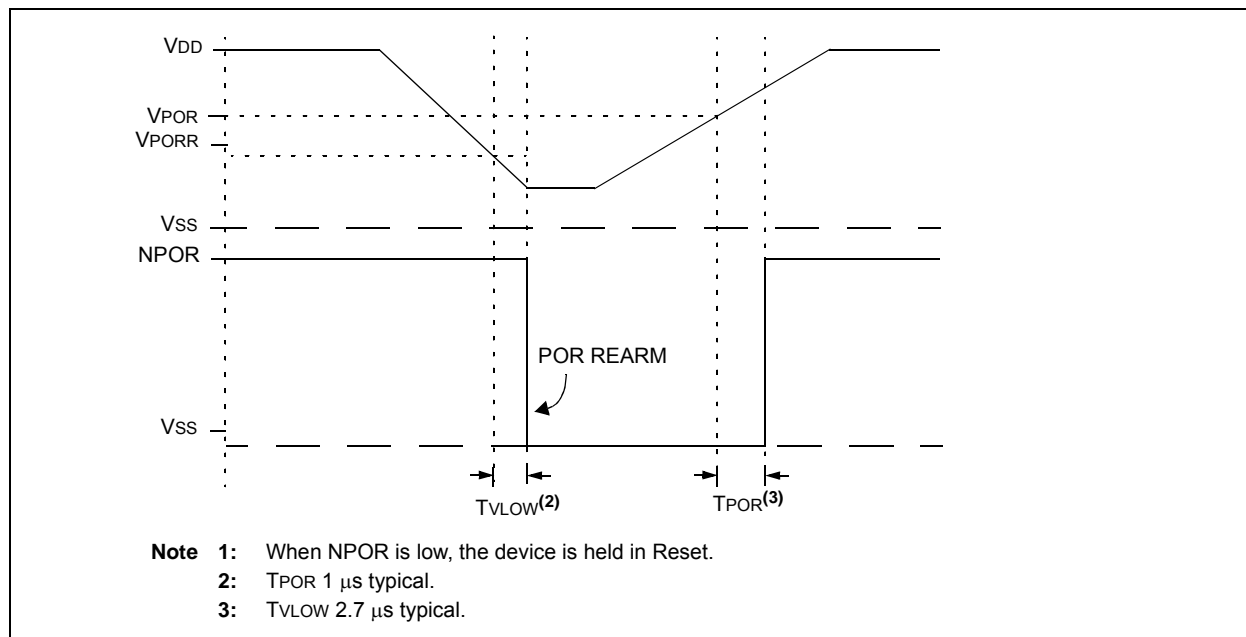
| PIC16LF1902/3 | | | Standard Operating Conditions (unless otherwise stated) | | | | |
|---------------|----------------------------------|--|---|-------|------|--------|---|
| Param. No. | Sym. | Characteristic | Min. | Typ† | Max. | Units | Conditions |
| D001 | VDD | Supply Voltage | 1.8 | — | 3.6 | V | Fosc ≤ 16 MHz |
| | | | 2.3 | — | 3.6 | V | Fosc ≤ 20 MHz (EC mode) |
| D002* | VDR | RAM Data Retention Voltage ⁽¹⁾ | 1.5 | — | — | V | Device in Sleep mode |
| D002A* | VPOR* | Power-on Reset Release Voltage | 1.54 | 1.64 | 1.74 | V | |
| D002B* | VPORR* | Power-on Reset Rearm Voltage | — | 1.7 | — | V | Device in Sleep mode |
| D003 | VADFVR | Fixed Voltage Reference Voltage for ADC, Initial Accuracy | 6 | — | 4 | % | 1.024V, VDD ≥ 1.8V, 85°C |
| | | | 7 | — | 4 | % | 1.024V, VDD ≥ 1.8V, 125°C |
| | | | 7 | — | 6 | % | 2.048V, VDD ≥ 2.5V, 85°C |
| | | | 8 | — | 6 | % | 2.048V, VDD ≥ 2.5V, 125°C |
| D003A | VCDAFVR | Fixed Voltage Reference Voltage for Comparator and DAC, Initial Accuracy | 7 | — | 5 | % | 1.024V, VDD ≥ 1.8V, 85°C |
| | | | 8 | — | 5 | % | 1.024V, VDD ≥ 1.8V, 125°C |
| | | | 8 | — | 7 | % | 2.048V, VDD ≥ 2.5V, 85°C |
| | | | 9 | — | 7 | % | 2.048V, VDD ≥ 2.5V, 125°C |
| D003B | VLCDFVR | Fixed Voltage Reference Voltage for LCD Bias, Initial Accuracy | 9 | — | 9 | % | 3.072V, VDD ≥ 3.6V, 85°C |
| | | | 9.5 | — | 9 | % | 3.072V, VDD ≥ 3.6V, 125°C |
| D003C* | TCVFVR | Temperature Coefficient, Fixed Voltage Reference | — | -130 | — | ppm/°C | |
| D003D* | $\Delta V_{FVR} / \Delta V_{IN}$ | Line Regulation, Fixed Voltage Reference | — | 0.270 | — | %/V | |
| D004* | SVDD | VDD Rise Rate to ensure internal Power-on Reset signal | 0.05 | — | — | V/ms | See Section 5.1 "Power-on Reset (POR)" for details. |

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.3V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in Sleep mode without losing RAM data.

FIGURE 21-3: POR AND POR REARM WITH SLOW RISING VDD



23.6 MPLAB X SIM Software Simulator

The MPLAB X SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB X SIM Software Simulator fully supports symbolic debugging using the MPLAB XC Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

23.7 MPLAB REAL ICE In-Circuit Emulator System

The MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs all 8, 16 and 32-bit MCU, and DSC devices with the easy-to-use, powerful graphical user interface of the MPLAB X IDE.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ-11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB X IDE. MPLAB REAL ICE offers significant advantages over competitive emulators including full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, logic probes, a ruggedized probe interface and long (up to three meters) interconnection cables.

23.8 MPLAB ICD 3 In-Circuit Debugger System

The MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost-effective, high-speed hardware debugger/programmer for Microchip Flash DSC and MCU devices. It debugs and programs PIC Flash microcontrollers and dsPIC DSCs with the powerful, yet easy-to-use graphical user interface of the MPLAB IDE.

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

23.9 PICkit 3 In-Circuit Debugger/Programmer

The MPLAB PICkit 3 allows debugging and programming of PIC and dsPIC Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB IDE. The MPLAB PICkit 3 is connected to the design engineer's PC using a full-speed USB interface and can be connected to the target via a Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the Reset line to implement in-circuit debugging and In-Circuit Serial Programming™ (ICSP™).

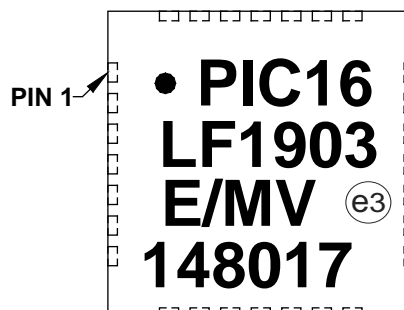
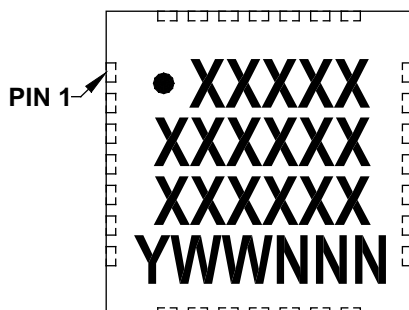
23.10 MPLAB PM3 Device Programmer

The MPLAB PM3 Device Programmer is a universal, CE compliant device programmer with programmable voltage verification at VDDMIN and VDDMAX for maximum reliability. It features a large LCD display (128 x 64) for menus and error messages, and a modular, detachable socket assembly to support various package types. The ICSP cable assembly is included as a standard item. In Stand-Alone mode, the MPLAB PM3 Device Programmer can read, verify and program PIC devices without a PC connection. It can also set code protection in this mode. The MPLAB PM3 connects to the host PC via an RS-232 or USB cable. The MPLAB PM3 has high-speed communications and optimized algorithms for quick programming of large memory devices, and incorporates an MMC card for file storage and data applications.

24.2 Package Marking Information

28-Lead UQFN (4x4x0.5 mm)

Example

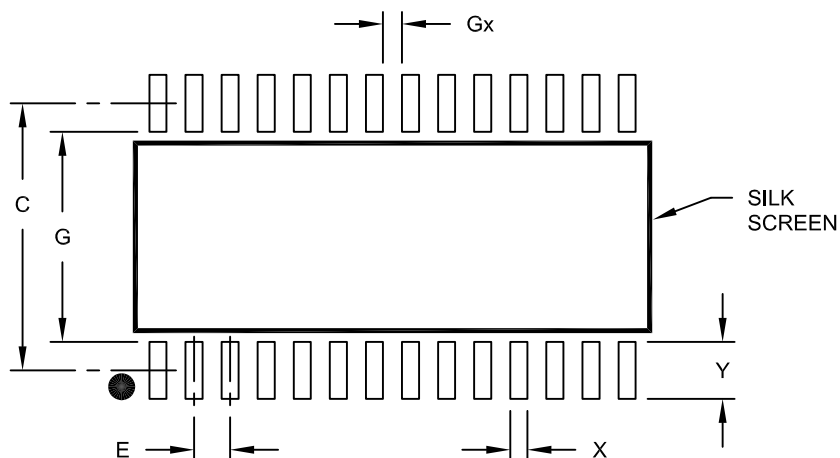


| | | |
|----------------|--------|---|
| Legend: | XX...X | Customer-specific information |
| | Y | Year code (last digit of calendar year) |
| | YY | Year code (last 2 digits of calendar year) |
| | WW | Week code (week of January 1 is week '01') |
| | NNN | Alphanumeric traceability code |
| | (e3) | Pb-free JEDEC [®] designator for Matte Tin (Sn) |
| | * | This package is Pb-free. The Pb-free JEDEC [®] designator (e3) can be found on the outer packaging for this package. |

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

| Units | | MILLIMETERS | | |
|--------------------------|----|-------------|------|------|
| Dimension Limits | | MIN | NOM | MAX |
| Contact Pitch | E | 1.27 BSC | | |
| Contact Pad Spacing | C | | 9.40 | |
| Contact Pad Width (X28) | X | | | 0.60 |
| Contact Pad Length (X28) | Y | | | 2.00 |
| Distance Between Pads | Gx | 0.67 | | |
| Distance Between Pads | G | 7.40 | | |

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

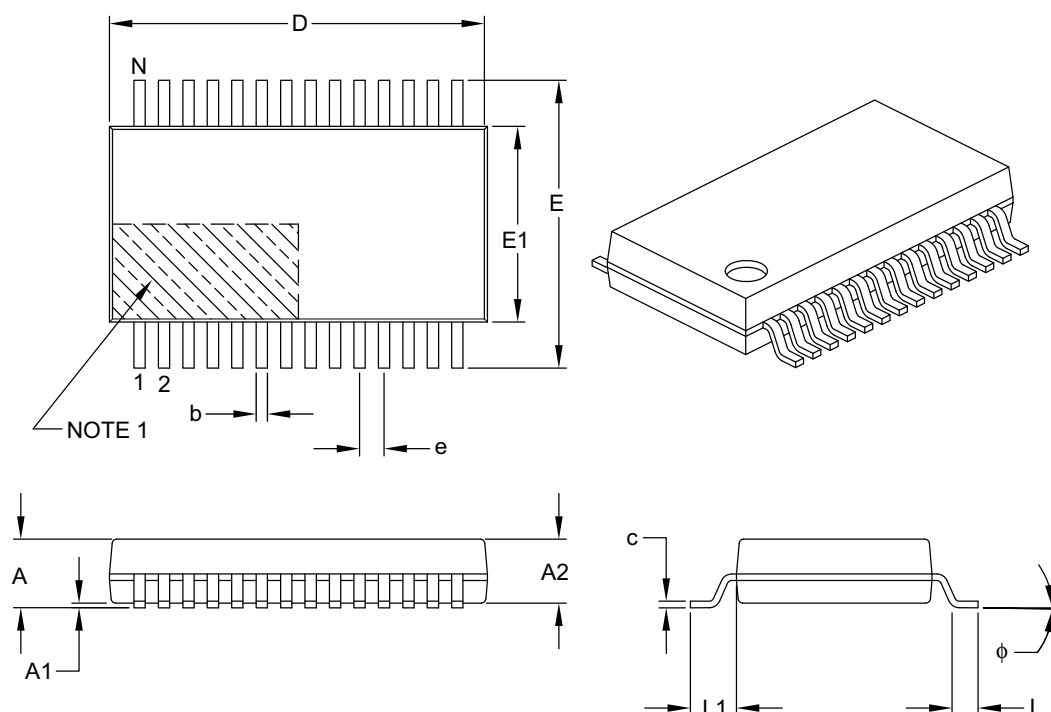
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2052A

PIC16LF1902/3

28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units | | MILLIMETERS | | |
|--------------------------|----|-------------|-------|-------|
| Dimension Limits | | MIN | NOM | MAX |
| Number of Pins | N | 28 | | |
| Pitch | e | 0.65 BSC | | |
| Overall Height | A | – | – | 2.00 |
| Molded Package Thickness | A2 | 1.65 | 1.75 | 1.85 |
| Standoff | A1 | 0.05 | – | – |
| Overall Width | E | 7.40 | 7.80 | 8.20 |
| Molded Package Width | E1 | 5.00 | 5.30 | 5.60 |
| Overall Length | D | 9.90 | 10.20 | 10.50 |
| Foot Length | L | 0.55 | 0.75 | 0.95 |
| Footprint | L1 | 1.25 REF | | |
| Lead Thickness | c | 0.09 | – | 0.25 |
| Foot Angle | φ | 0° | 4° | 8° |
| Lead Width | b | 0.22 | – | 0.38 |

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B